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Additional names of conveying party(ies) attached?  yes no	Internal Address:
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3. Nature of Conveyance	A New York corporation
X Assignment	1
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4. Application number(s) or patent number(s):  Title: <u>DYNAMICALLY REPLACING A FAILED CHIP</u> If this document is being filed together with a new application, t	he execution date of the application is
A. Patent Application No(s). B.	Patent No(s).
09302917 Additional numbers attack	hed? 🗌 Yes 🛛 No
5. Name and address of party to whom correspondence	6. Total number of applications and patents involved: 1
concerning	
document should be mailed:	7. Total fee (37 CFR 3.41): \$_40.00
William N. Hogg	<u> </u>
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## **ASSIGNMENT**

Whereas, we

Inventor and City

- (1) CLAUDE L. BERTIN City of South Burlington County of Chittendon and State of Vermont
- (2) TIMOTHY J. DELL City of Colchester County of Chittenden and State of Vermont
- (3) ERIK L. HEDBERG City of Essex Junction County of Chittenden and State of Vermont

have invented certain improvements in

## Title DYNAMICALLY REPLACING A FAILED CHIP

Date That Inventor Signed the

Declaration

and have executed, respectively, a United States patent application therefor on

(1) 
$$\frac{12}{29}$$
  $\frac{29}{1999}$ , and (2)  $\frac{1999}{1999}$ , and (3)  $\frac{4}{29}$   $\frac{29}{1999}$ , and

Whereas, INTERNATIONAL BUSINESS MACHINES CORPORATION, a corporation of New York, having a place of business at Armonk, New York 10504, (hereinafter called IBM), desires to acquire the entire right, title and interest in the said application and invention, and to any United States and foreign patent to be obtained therefor;

Now therefore, for a valuable consideration, receipt whereof is hereby acknowledged, I the above named hereby sell, assign, and transfer to IBM, its successors and assigns, the entire right, title and interest in the said application and invention therein disclosed for the United States and foreign countries, and all rights of priority resulting from the filing of said United States application, and I request the Commissioner of Patents to issue and Letters Patent granted upon the invention set forth in said application to IBM, its successors and assigns; and I hereby agree that IBM may apply for foreign Letters Patent on said invention and I will execute all papers necessary in connection with the United States and foreign applications when called upon to do so by IBM.

PAGE 1 of 2

City	(1) Signed at Esser Sunction 1	
Date	on 29/19x 1999  (CLAUDE L. BERTIN	_Signature )inventor
City	(2) Signed at Essex Junction, VT	
Date	on 4-29-99 (TIMOTHY J. DELL	_Signature )inventor
City	(3) Signed at Tosex Junction VT.	
Date	on 4/29/99 Ent L. Hedberg (ERIK L. HEDBERG)	_Signature )inventor

**RECORDED: 04/30/1999**